



BT169

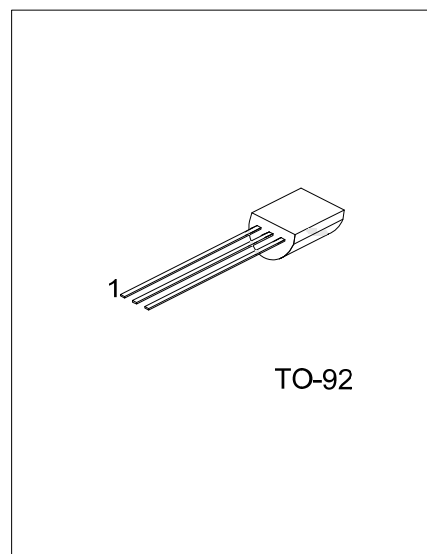
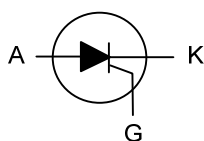
SCR

SCRS

DESCRIPTION

Passivated, sensitive gate thyristors in a plastic envelope, intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

SYMBOL



Lead-free: BT169xL
Halogen-free: BT169xG

ORDERING INFORMATION

Ordering Number			Package	Pin Assignment			Packing
Normal	Lead Free	Halogen Free		1	2	3	
BT169B-T92-B	BT169BL-T92-B	BT169BG-T92-B	TO-92	K	G	A	Tape Box
BT169B-T92-K	BT169BL-T92-K	BT169BG-T92-K	TO-92	K	G	A	Bulk
BT169D-T92-B	BT169DL-T92-B	BT169DG-T92-B	TO-92	K	G	A	Tape Box
BT169D-T92-K	BT169DL-T92-K	BT169DG-T92-K	TO-92	K	G	A	Bulk
BT169E-T92-B	BT169EL-T92-B	BT169EG-T92-B	TO-92	K	G	A	Tape Box
BT169E-T92-K	BT169EL-T92-K	BT169EG-T92-K	TO-92	K	G	A	Bulk
BT169G-T92-B	BT169GL-T92-B	BT169GP-T92-B	TO-92	K	G	A	Tape Box
BT169G-T92-K	BT169GL-T92-K	BT169GP-T92-K	TO-92	K	G	A	Bulk
BT169H-T92-B	BT169HL-T92-B	BT169HG-T92-B	TO-92	K	G	A	Tape Box
BT169H-T92-K	BT169HL-T92-K	BT169HG-T92-K	TO-92	K	G	A	Bulk

Note: Pin Assignment: C:CATHODE G:GATE A:ANODE

BT169xL-T92-B	(1)Packing Type (2)Package Type (3)Lead Plating (4)Repetitive Peak Off-State Voltages	(1) B: Tape Box, K: Bulk (2) T92: TO-92 (3) G: Halogen Free, L: Lead Free, Blank: Pb/Sn P: Halogen Free(for BT169G) (4) x: refer to Quick Reference data
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■ QUICK REFERENCE DATA

PARAMETER	SYMBOL	BT169B	BT169D	BT169E	BT169G	BT169H	UNIT
		MAX	MAX	MAX	MAX	MAX	MAX
Repetitive Peak Off-State Voltages	V_{DRM}, V_{RRM}	200	400	500	600	800	V
Average On-State Current	$I_{T(AV)}$	0.5	0.5	0.5	0.5	0.5	A
RMS On-State Current	$I_{T(RMS)}$	0.8	0.8	0.8	0.8	0.8	A
Non-Repetitive Peak On-State Current	I_{TSM}	8	8	8	8	8	A

■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Repetitive Peak Off-State Voltages(Note 2)	BT169B	V_{DRM}, V_{RRM}	200	V
	BT169D		400	
	BT169E		500	
	BT169G		600	
	BT169H		800	
Peak Gate Voltage		V_{GM}	5	V
Peak Reverse Gate Voltage		V_{RGM}	5	V
Peak Gate Current		I_{GM}	1	A
Average On-State Current (Half Sine Wave, $T_{LEAD} \leq 83^{\circ}\text{C}$)		$I_{T(AV)}$	0.5	A
RMS On-State Current (All Conduction Angles)		$I_{T(RMS)}$	0.8	A
Non-Repetitive Peak On-State Current (Half Sine Wave, $T_J=25^{\circ}\text{C}$ Prior to Surge)	$t=10\text{ms}$	I_{TSM}	8	A
	$t=8.3\text{ms}$		9	A
I^2t For Fusing ($t=10\text{ms}$)		I^2t	0.32	A^2S
Repetitive Rate of Rise of On-State Current After Triggering ($I_{TM}=2\text{A}, I_G=10\text{mA}, dI_G/dt=100\text{mA}/\mu\text{s}$)		dI_T/dt	50	$\text{A}/\mu\text{s}$
Peak Gate Power		P_{GM}	2	W
Average Gate Power (Over any 20 ms period)		$P_{G(AV)}$	0.1	W
Junction Temperature		T_J	+125	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-40 ~ +150	$^{\circ}\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. 1 Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/ μs .

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Thermal Resistance Junction to Ambient (typ.)	θ_{JA}	150	$^{\circ}\text{C}/\text{W}$

Note: pcb mounted, lead length=4mm

■ ELECTRICAL CHARACTERISTICS ($T_J=25^{\circ}\text{C}$, unless otherwise specified)

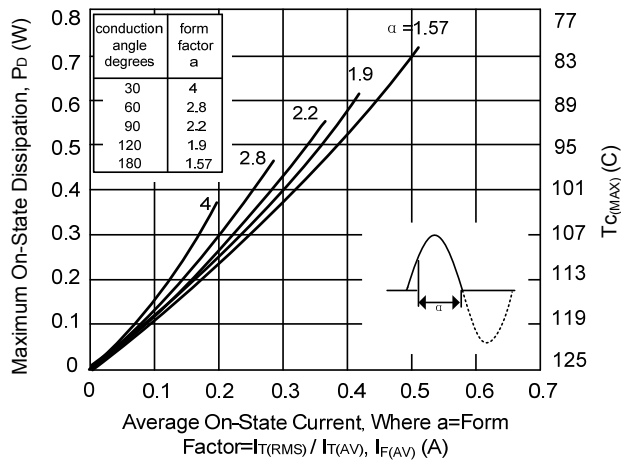
PARAMETER	SYMBOL	TSET CONDITIONS	MIN	TYP	MAX	UNIT
STATIC CHARACTERISTICS						
Gate Trigger Current	I_{GT}	$V_D=12\text{V}, I_T=10\text{mA}$, gate open circuit	25		55	μA
Latching Current	I_L	$V_D=12\text{V}, I_{GT}=0.5\text{mA}, R_{GK}=1\text{k}\Omega$		2	6	mA
Holding Current	I_H	$V_D=12\text{V}, I_{GT}=0.5\text{mA}, R_{GK}=1\text{k}\Omega$		2	5	mA
On-State Voltage	V_T	$I_T=1\text{A}$		1.2	1.35	V
Gate Trigger Voltage	V_{GT}	$V_D=12\text{V}, I_T=10\text{mA}$, gate open circuit $V_D=V_{DRM(MAX)}, I_T=10\text{mA}, T_J=125^{\circ}\text{C}$, gate open circuit	0.2	0.5 0.3	0.8	V
Off-State Leakage Current	I_D, I_R	$V_D=V_{DRM(MAX)}, V_R=V_{RRM(MAX)},$ $T_J=125^{\circ}\text{C}, R_{GK}=1\text{k}\Omega$		0.05	0.1	mA

■ ELECTRICAL CHARACTERISTICS(Cont.)

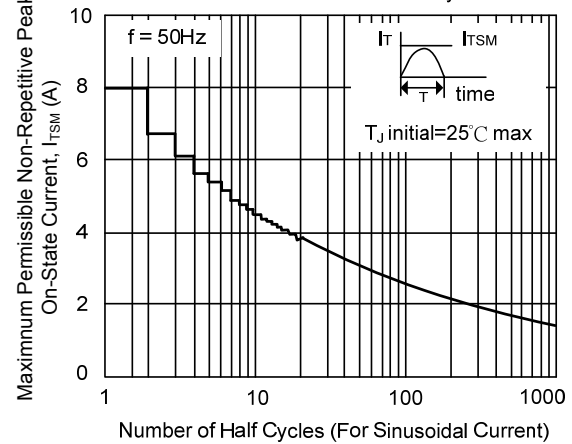
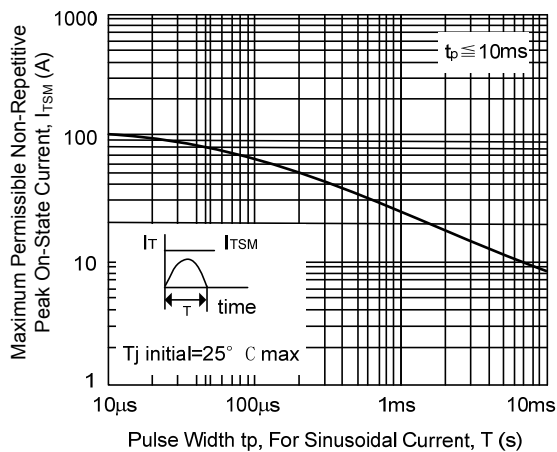
PARAMETER	SYMBOL	TSET CONDITIONS	MIN	TYP	MAX	UNIT
DYNAMIC CHARACTERISTICS						
Critical Rate of Rise of Off-State Voltage	dV_D/dt	$V_{DM}=67\% V_{DRM(MAX)}$, $T_J=125^\circ\text{C}$, exponential waveform, $R_{GK}=1\text{k}\Omega$	500	800		V/ μs
Gate Controlled Turn-On Time	t_{gt}	$I_{TM}=2\text{A}$, $V_D=V_{DRM(MAX)}$, $I_G=10\text{mA}$, $dI_G/dt=0.1\text{A}/\mu\text{s}$		2		μs
Circuit Commutated Turn-Off Time	t_q	$V_D=67\% V_{DRM(MAX)}$, $T_J=125^\circ\text{C}$, $I_{TM}=1.6\text{A}$, $V_R=35\text{V}$, $dI_{TM}/dt=30\text{A}/\mu\text{s}$, $V_D/dt=2\text{V}/\mu\text{s}$, $R_{GK}=1\text{k}\Omega$		100		μs

■ TYPICAL CHARACTERISTICS

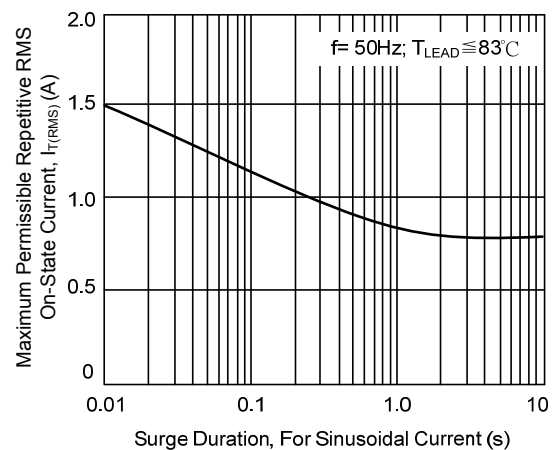
Maximum On-State Dissipation vs. Average On-State Current



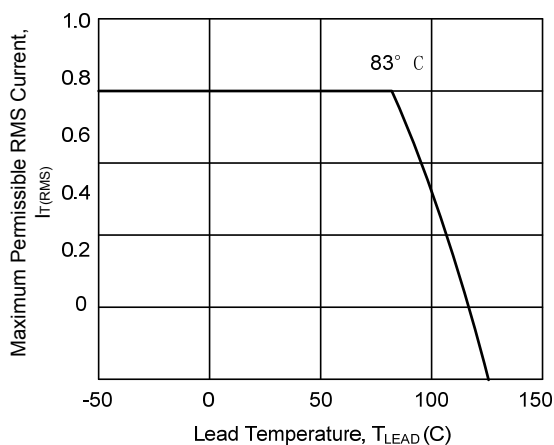
Maximum Permissible Non-Repetitive Peak On-State Current vs. Number Of Cycles

Maximum Permissible Non-Repetitive Peak On-State Current vs. Pulse Width t_p , For Sinusoidal Current

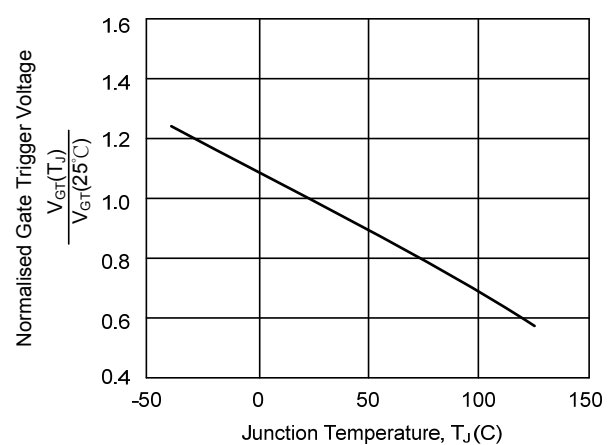
Maximum Permissible Repetitive RMS On-State Current vs. Surge Duration, For Sinusoidal Currents



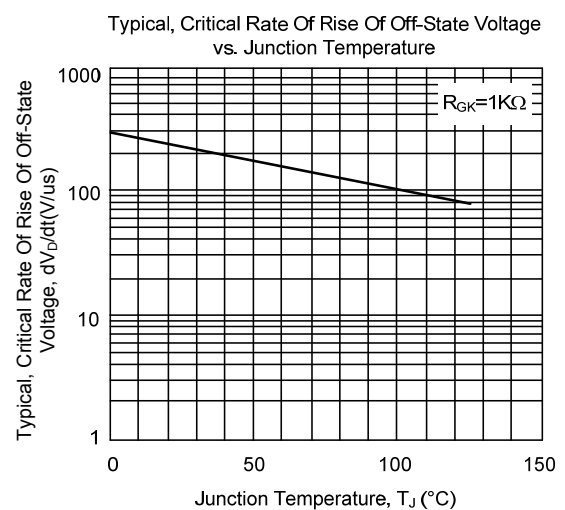
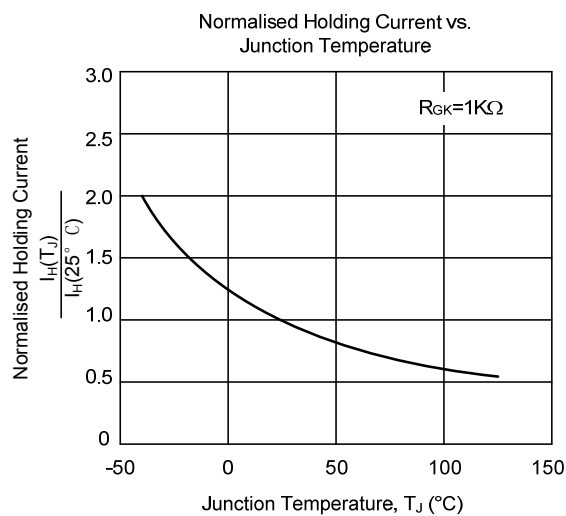
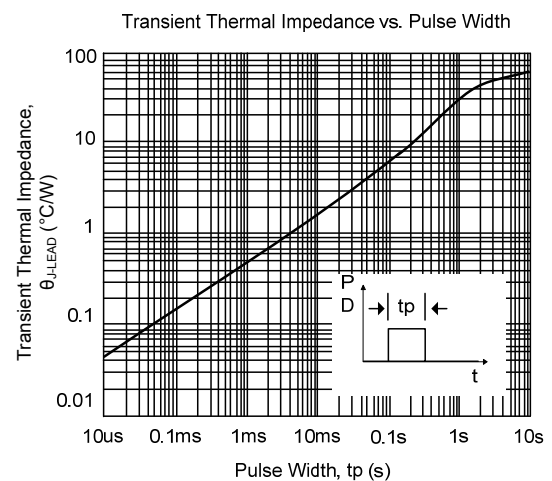
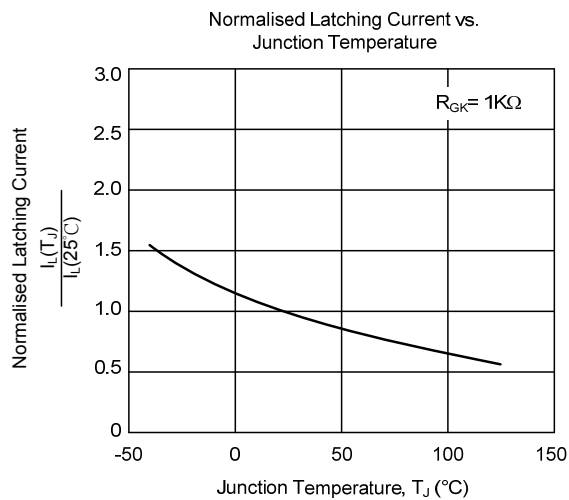
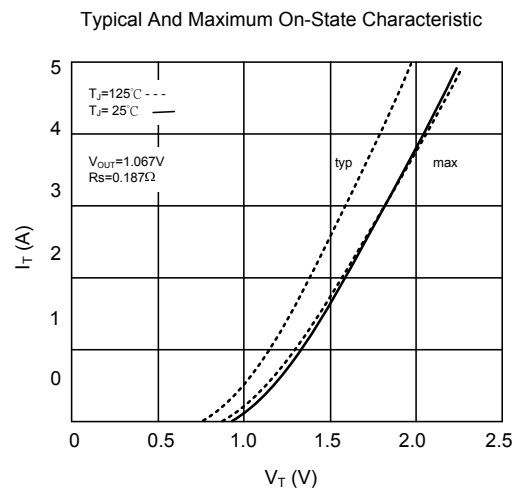
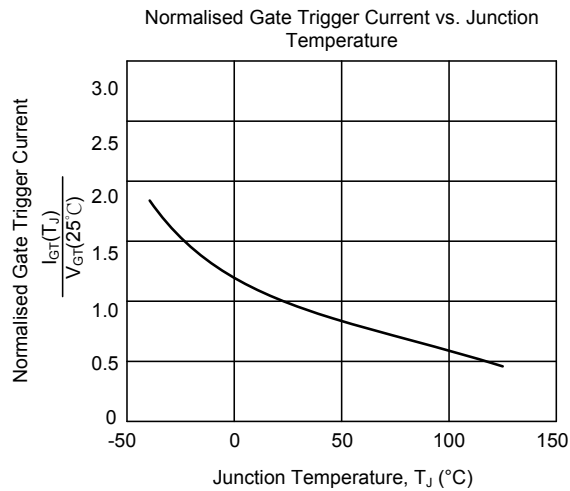
Maximum Permissible RMS Current vs. Lead Temperature



Normalised Gate Trigger Voltage vs. Junction Temperature



TYPICAL CHARACTERISTICS(Cont.)



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